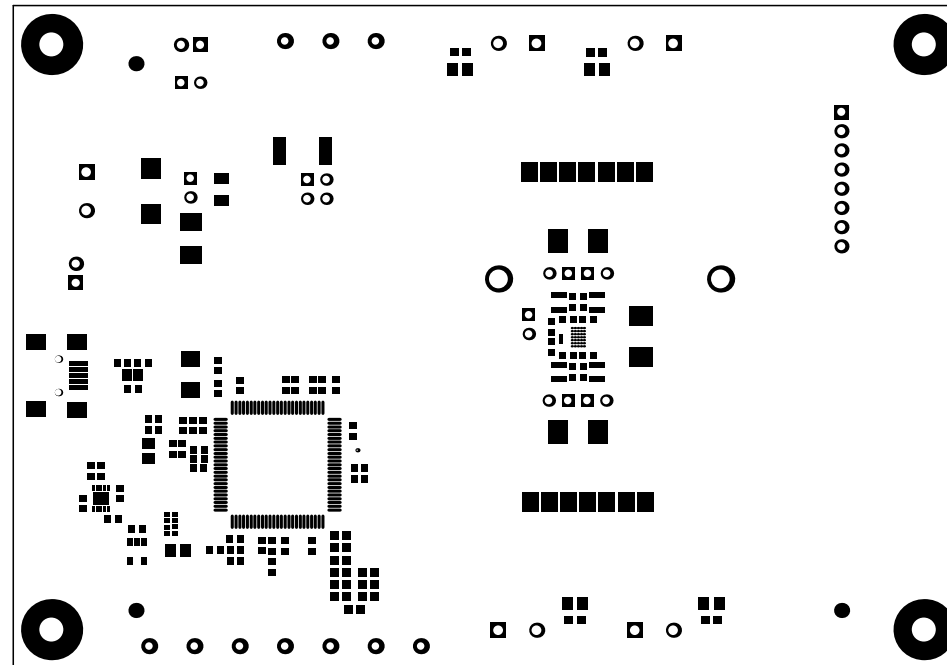
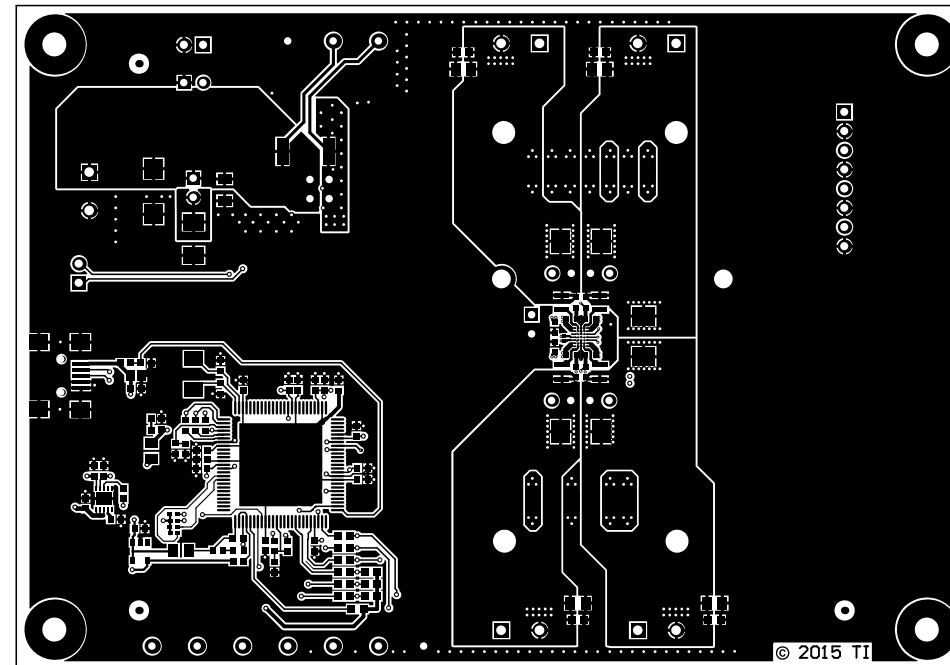


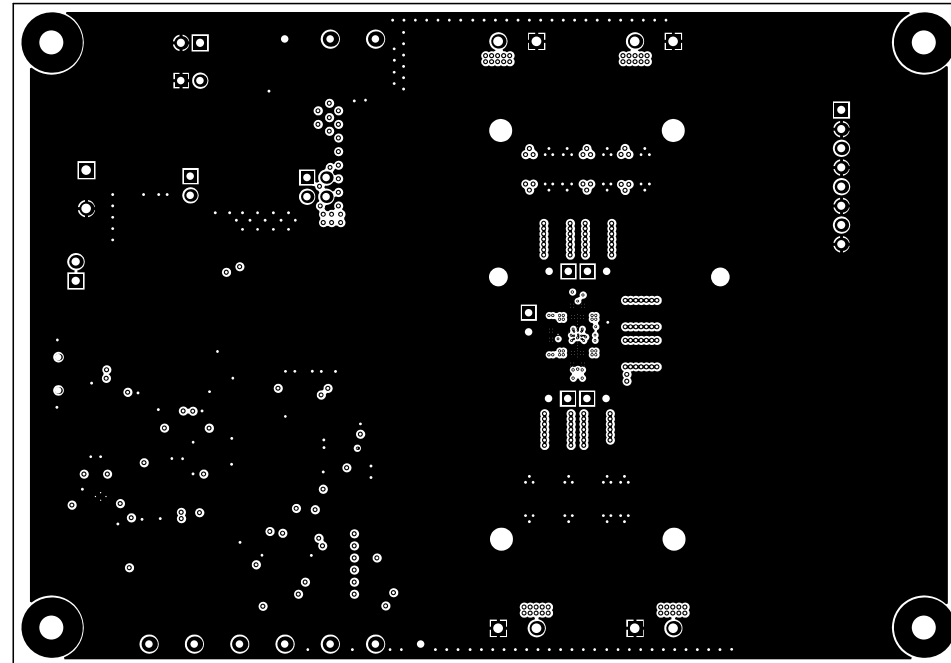
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 12/22/2015 10:40:35 AM	TEXAS INSTRUMENTS	



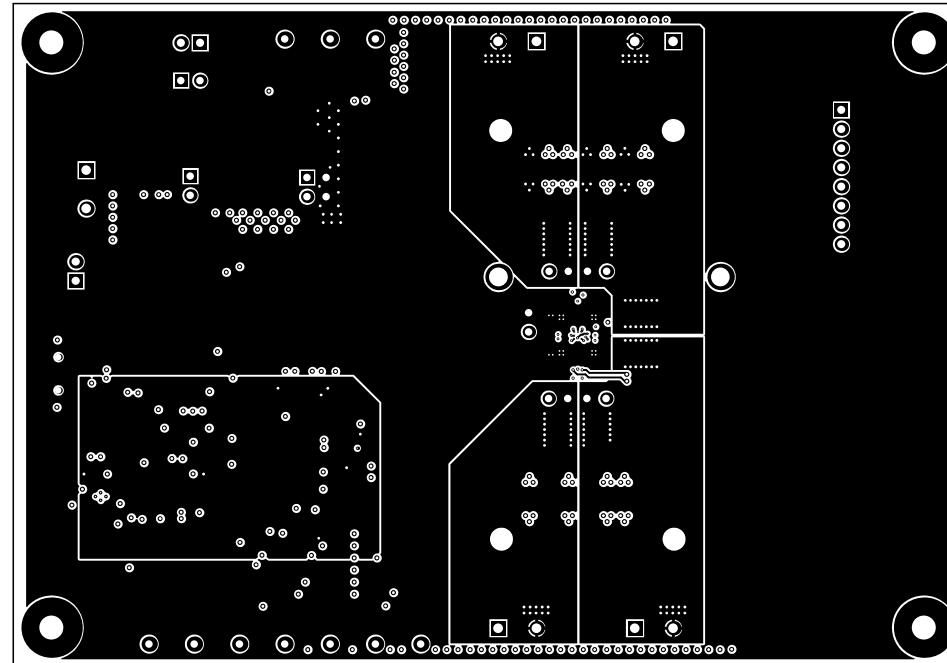
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 12/22/2015 10:40:36 AM	TEXAS INSTRUMENTS	



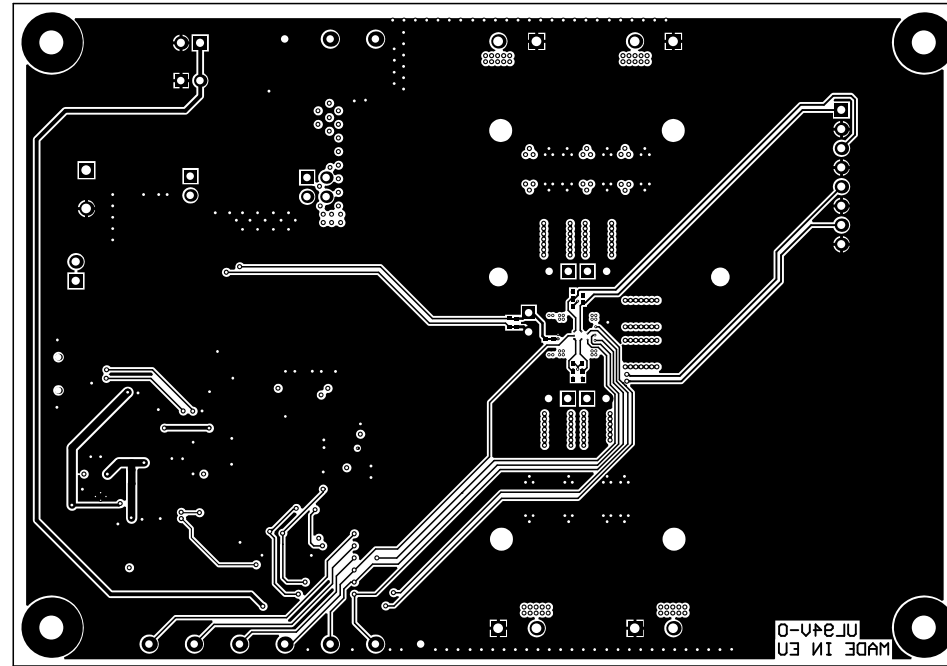
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 12/22/2015 10:40:37 AM	TEXAS INSTRUMENTS	



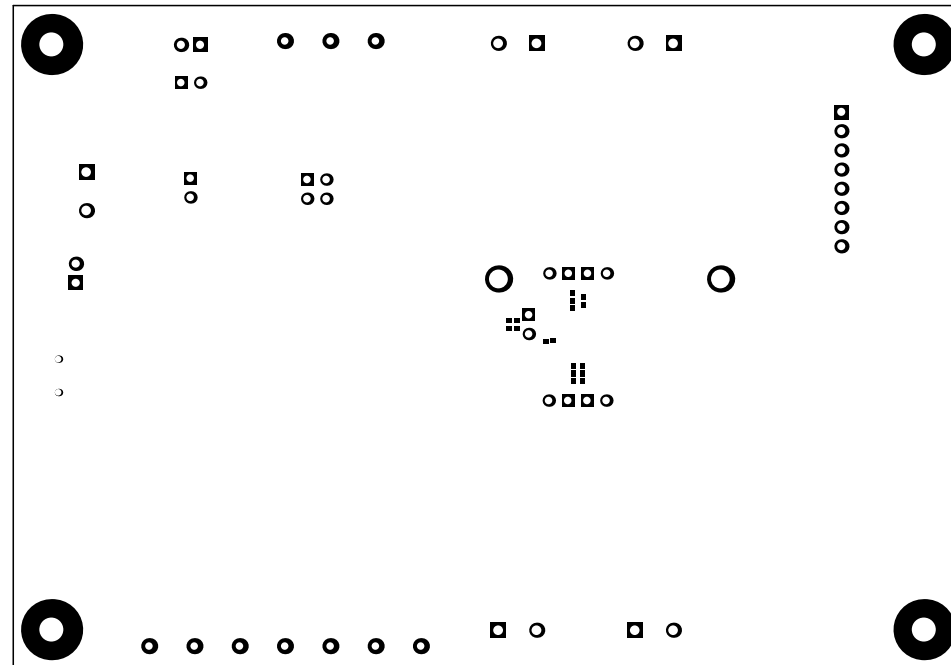
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = MidLayer1			
PLOT NAME = MidLayer1	GENERATED : 12/22/2015 10:40:38 AM	TEXAS INSTRUMENTS	



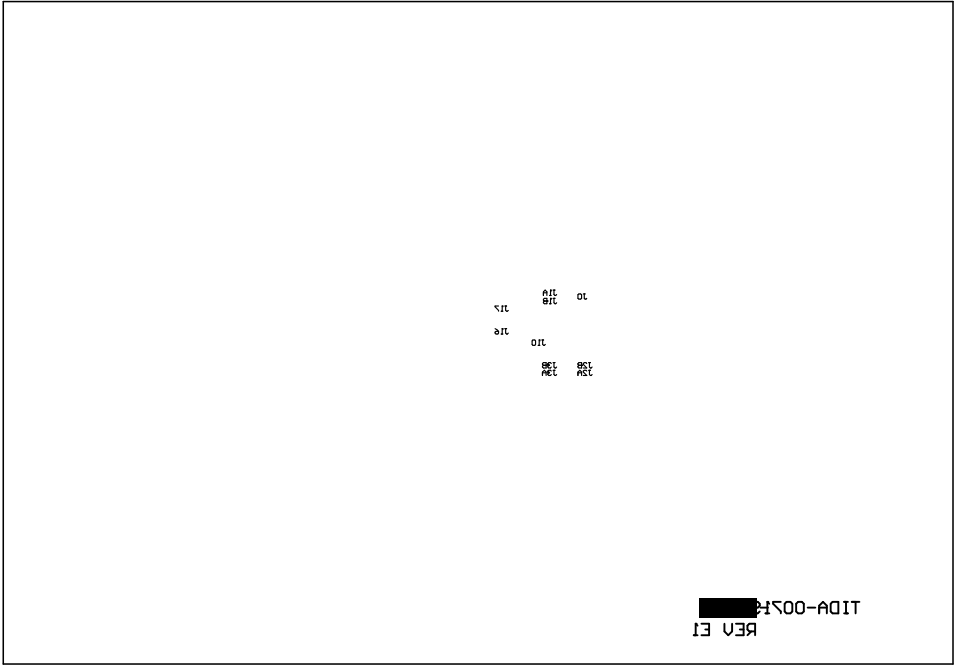
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = MidLayer2			
PLOT NAME = MidLayer2	GENERATED : 12/22/2015 10:40:39 AM	TEXAS INSTRUMENTS	



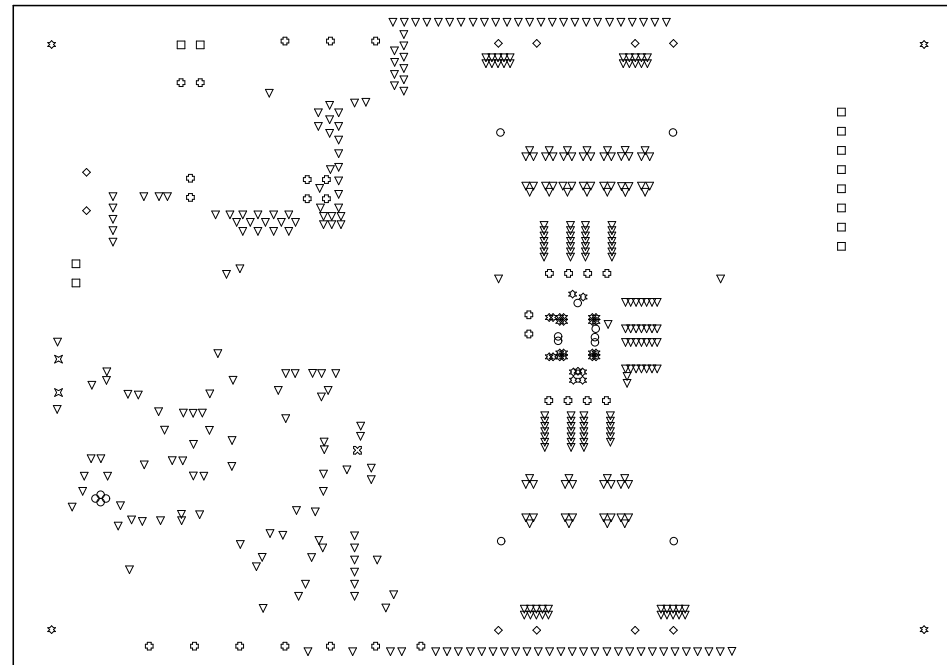
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 12/22/2015 10:40:40 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 12/22/2015 10:40:41 AM	TEXAS INSTRUMENTS	



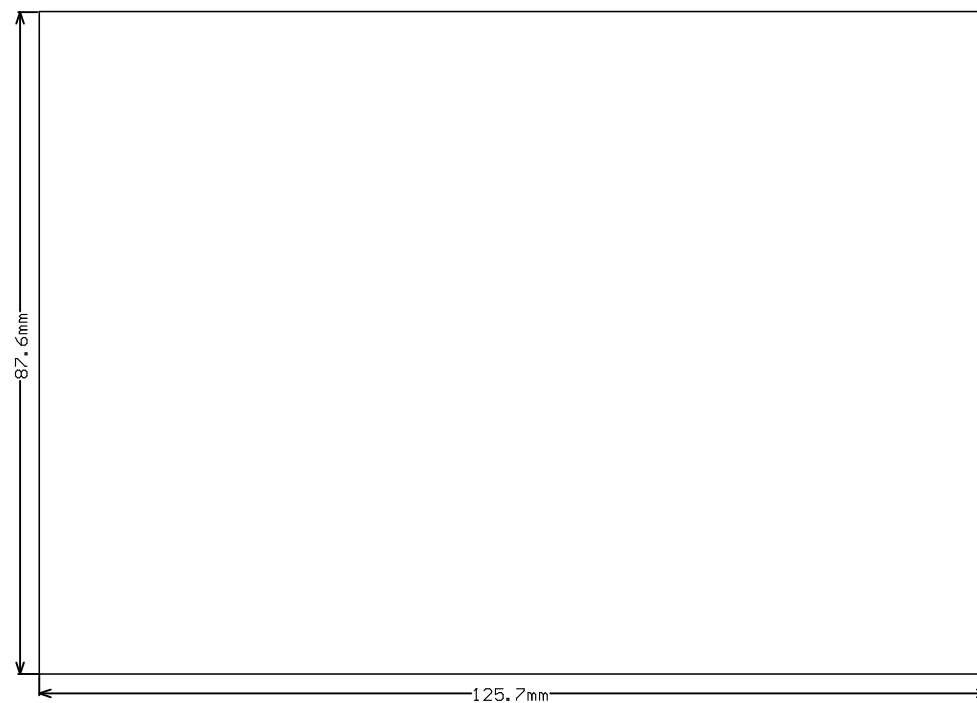
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 12/22/2015 10:40:42 AM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
○	10	0.2mm (7.874mil)	PTH	Round
⊗	1	0.203mm (8mil)	PTH	Round
*	27	0.25mm (9.842mil)	PTH	Round
▽	387	0.4mm (15.748mil)	PTH	Round
⊗	2	0.9mm (35.433mil)	NPTH	Round
⊗	28	1.016mm (40mil)	PTH	Round
□	12	1.1mm (43.307mil)	PTH	Round
◇	10	1.3mm (51.181mil)	PTH	Round
▽	2	2.5mm (98.425mil)	PTH	Round
○	4	2.54mm (100mil)	NPTH	Round
*	4	3.2mm (125.984mil)	PTH	Round
487 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 12/22/2015 10:40:43 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00719	REV: 001	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 12/22/2015 10:40:43 AM	TEXAS INSTRUMENTS	

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